

# United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address. COMMISSIONER OF PATENTS AND TRADEMARKS PO Box 1450 Alexandra, Vignus 22313-1440 www.uepto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/001,271	12/04.2001	Mike C. Loo	US 018154	2095	
7	590 06-03/2003				
Corporate Pat Philips North A 580 White Plai Tarrytown, NY	America Corporation ns Road		EXAMINER DINH, TUAN T		
rarrytown, N 1	10391		ART UNIT	PAPER NUMBER	
			2827		
			DATE MAILED: 06/03/2003		

Please find below and/or attached an Office communication concerning this application or proceeding.

	Applic	ation No.	Applicant(s)	
	10/00	1,271	LOO, MIKE C.	
Office Action Summary	Exami	ner	Art Unit	
	Tuan T	Dinh	2027	
The MAILING DATE of this community of the Period for Reply	unication appears on	the cover sheet w	ith the correspondence address	
A SHORTENED STATUTORY PERIOD THE MAILING DATE OF THIS COMMUI  - Extensions of time may be available under the provision after SIX (6) MONTHS from the mailing date of this core. If the period for reply specified above is less than thirty. If NO period for reply is specified above, the maximum - Failure to reply within the set or extended period for reply are accepted by the Office later than three months earned patent term adjustment. See 37 CFR 1.704(b).	ins of 37 CFR 1.136(a). In no mmunication. (30) days, a reply within the statutory period will apply an oly will, by statute, cause the is after the mailing date of this	event, however, may a restatutory minimum of thirt d will expire SIX (6) MON application to become AB communication, even if the event of the event	eply be timely filed y (30) days will be considered timely. THS from the mailing date of this communication	
1) Responsive to communication(s)	filed on <u>03 February</u>	<u> 2003</u> .		
2a) This action is <b>FINAL</b> .	2b) This action	is non-final.		
3) Since this application is in condition closed in accordance with the practice of Claims	onde under Ex parte	ept for formal mat <i>Quayle</i> , 1935 C.E	ters, prosecution as to the merits i D. 11, 453 O.G. 213.	
4) $\boxtimes$ Claim(s) <u>1-10</u> is/are pending in the	application.			
4a) Of the above claim(s) <u>6-10</u> is/ar	e withdrawn from co	nsideration.		
5) Claim(s) is/are allowed.				
6)⊠ Claim(s) <u>1-5</u> is/are rejected.				
7)☐ Claim(s) is/are objected to.				
8) Claim(s) are subject to restri	ction and/or election	requirement.		
9) The specification is objected to by the	e Examiner			
10) The drawing(s) filed on is/are:		Objected to by th	e Evaminor	
Applicant may not request that any ob	jection to the drawing(	s) be held in ahevar	300 Sec 37 CED 1 05(-)	
11) The proposed drawing correction file	d on is: a) ☐	approved b) dis	Sapproved by the Examinor	
ir approved, corrected drawings are re	quired in reply to this (	Office action.	supplied by the Examiner.	
12)☐ The oath or declaration is objected to	by the Examiner.			
riority under 35 U.S.C. §§ 119 and 120				
13) Acknowledgment is made of a claim	for foreign priority u	nder 35 U.S.C. &	119(a)-(d) or (f)	
a)☐ All b)☐ Some * c)☐ None of:	•		rio(a) (a) or (i).	
1. Certified copies of the priority	documents have bee	en received.		
2. Certified copies of the priority	documents have bee	en received in Apr	olication No	
Copies of the certified copies of application from the Intern     See the attached detailed Office action	of the priority docum	ents have been re	eceived in this National Stage	
14) Acknowledgment is made of a claim fo	or domestic priority u	nder 35 U.S.C. &	119(e) (to a provisional access of	
a) The translation of the foreign lan 15) Acknowledgment is made of a claim for	Quage provisional ar	inlication has been	m manastr - t	
acriment(s)	•	272133	y . = = =	
Notice of References Cited (PTO-892)  Notice of Draftsperson's Patent Drawing Review (PTD Information Disclosure Statement(s) (PTO-1449) Pa	ΓΟ-948) per No(s)	4) Interview Sur 5) Notice of Info 6) Other:	mmary (PTO-413) Paper No(s) ormal Patent Application (PTO-152)	
atent and Trademark Office -326 (Rev. 04-01)	Office Action Summa		Part of Paper No. 4	

### **DETAILED ACTION**

### Election/Restrictions

1. Applicant's election with traverse of Specie II (figure 3, claims 1-5) in Paper No. 3 is acknowledged. The traversal is on the ground(s) that there are no distinct between Species I-IV. This is not found persuasive because Specie I teaches a substrate having non-designated bump and bump pad location and Specie II shows a substrate having designated bump and bump pad patterns with appropriate microvia connections, and also, Species III and IV have different embodiments in a plan view of two bump patterns on a flip chip.

The requirement is still deemed proper and is therefore made FINAL. Claims 6-10 are withdrawn from further consideration as being drawn to non-elected subject matter.

## Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- Claims 1-5 are rejected under 35 U.S.C. 102(b) as being anticipated by Dohya
   (U. S. Patent 5,012,047)

As to claim 1, Dohya discloses a substrate (1, column 1, line 68) for flip chip packaging as shown in figure 1, comprising:

Application/Control Number: 10/001,271

Art Unit: 2827

a multiple layer substrate having a first layer (12b, column 2, line 1) forming a signal plane and second and third layers (13, 14) beneath said first layer, said second and third layers forming selectively power and ground planes;

power, ground and signal bump pads (15; column 2, line 8) on said first layer, said power and ground bump pads extending in parallel rows in a designated position; and microvias (17, column 2, line 7) connecting said power bump pads directly to said power plane and said ground bump pads directly to said ground plane.

As to claim 2, Dohya discloses the substrate as shown in figure 1 including a further signal plane (16) below said power and ground planes (13, 14), and microvias (17) connecting related signal bump pads on said first layer to said further signal plane.

As to claims 3-4, Dohya discloses in figure 1 the substrate wherein said first layer (12b, layer 12b includes all layers 12a, 19, and 11) on a top surface of said substrate, and said further signal plane (16) on a bottom surface of said substrate.

As to claim 5, Dohya discloses the substrate in figure 1 wherein said signal bump pads extending ins parallel rows; said rows of signal power and ground bump pads positioned sequentially in the order of positioning of said signal, power and ground planes..

#### Conclusion

4. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Tsukada et al., Lan et al., Enomoto, and Kambe et al. disclose related art.

Application/Control Number: 10/001,271

Art Unit: 2827

Page 4

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Tuan T Dinh whose telephone number is 703-306-5856. The examiner can normally be reached on M-F.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David L. Talbott can be reached on 703-305-9883. The fax phone numbers for the organization where this application or proceeding is assigned are 703-305-1341 for regular communications and 703-305-1341 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

**TD** June 1, 2003

BAVID L. TALBOTT SUPERVISORY PAYSHY EYAMINEH

TECHNOLOGY CENTER 2800